



## Final Product Change Notification

202302037F01 : Qualification of an Additional Probe Test Site for LS1046/1026 Family of Devices

**Note:** This notice is NXP Company Proprietary.

**Issue Date:** Mar 06, 2023 **Effective date:** Jun 04, 2023

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### Management summary

Qualification of an additional probe test site for LS1046/1026 Family of devices.

### Change Category

- |  |   |  |   |   |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process   | <input type="checkbox"/> Assembly Process   | <input type="checkbox"/> Product Marking           | <input type="checkbox"/> Test Process   | <input type="checkbox"/> Design                         |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification  | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Errata                         |
| <input type="checkbox"/> Wafer Fab Location  | <input type="checkbox"/> Assembly Location  | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Location  | <input type="checkbox"/> Electrical spec./Test coverage |
- Firmware  Other: Probe location

## PCN Overview

### Description

NXP is pleased to announce an additional probe test site for the LS1046/1026 Family of devices, which is currently probed at ArdentecTaiwan (ADT). The same Automated Test Equipment (ATE) and identical probecard design is used at NXP-ATKL (Assembly & Test Kuala Lumpur) Probe. The added site helps provide assurance of supply for this product and helps to avoid delivery interruptions.

### Reason

Supply assurance and avoid delivery interruptions.

### Identification of Affected Products

Product identification does not change

### Product Availability

### Sample Information

Samples are available upon request

### Production

Planned first shipment

### Anticipated Impact on Form, Fit, Function, Reliability or Quality

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No Impact on form, fit, function, reliability or quality

**Disposition of Old Products**

Existing inventory will be run and ship as per normal.

**Additional information**

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Self qualification:[view online](#)

**Timing and Logistics**

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In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Apr 05, 2023.

**Contact and Support**

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For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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